PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|----------------------|----------------|---|
| 1.1 Company | life.augmented | STMicroelectronics International N.V |
| 1.2 PCN No. | | AMS/23/14256 |
| 1.3 Title of PCN | | Assy and testing manufacturing transfer for products in PDIP16-18-20 outsourced from ST Muar-Malaysia to ATX-China. |
| 1.4 Product Category | | Pls refer to the Products List |
| 1.5 Issue date | | 2023-08-09 |

| 2. PCN Team | | |
|---------------------------|--------------------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | NEMETH KRISZTINA | |
| 2.1.2 Phone | +49 89460062210 | |
| 2.1.3 Email | krisztina.nemeth@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Marcello SAN BIAGIO, Domenico ARRIGO | |
| 2.1.2 Marketing Manager | Salvatore DI VINCENZO, Fabio CHELLI | |
| 2.1.3 Quality Manager | Jean-Marc BUGNARD,Alessandro PLATINI | |

| 3. Change | | |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| | Product transfer from one site to another site, even if test or process line is qualified | ATX-KunShan (China) |

| 4. Description of change | | |
|---|---|--|
| | Old | New |
| 4.1 Description | Assy and Testing in St Muar (Malaysia). | PHASE1 (intermediate configuration): Assy in MUAR and Testing both in MUAR and ATX-KunShan (China). PHASE2 (final configuration): Assy and Testing in ATX-KunShan (China). |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact on form, fit, function, reliability, or processability. | |

| 5. Reason / motivation for change | | |
|---|--------------------|--|
| 5.1 Motivation ST Muar PDIP16-18-20 manufacturing lines will be shut down mid of Q2-2024. Full equipm for assembling of the ST products will be transferred to ATX-KunShan facilities (China). | | |
| 5.2 Customer Benefit | SERVICE CONTINUITY | |

| 6. Marking of parts / traceability of change | | |
|--|-----------------------------------|--|
| 6.1 Description | By Traceability Codes and Marking | |

| 7. Timing / schedule | | |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results | 2025-01-31 | |
| 7.2 Intended start of delivery | 2025-03-31 | |
| 7.3 Qualification sample available? | Upon Request | |

| 8. Qualification / Validation | | | |
|--|--|---------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | | Issue Date | |

9. Attachments (additional documentations)

14256 Public product.pdf

| 10. Affected parts | | |
|-------------------------|-------------------------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| L293D | L293D | |
| L297/1 | L297/1 | |
| ULN2064B | ULN2064B | |
| ULN2803A | ULN2803A | |
| ULN2804A | ULN2804A | |

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